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Device Pin Assignment

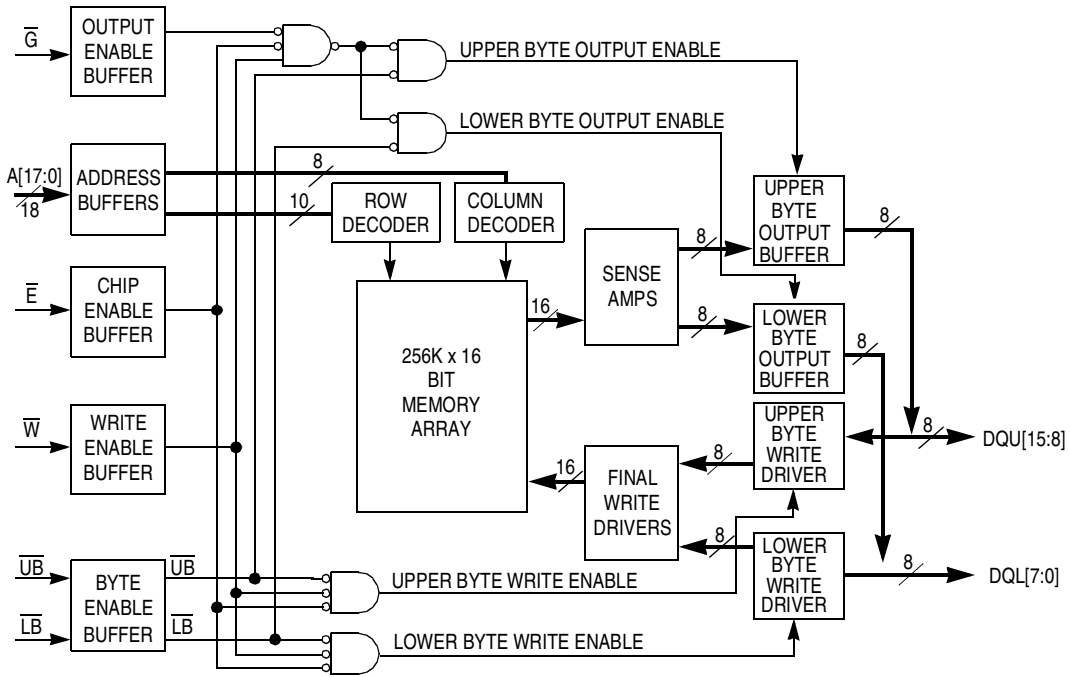


Figure 1. Block Diagram

Device Pin Assignment

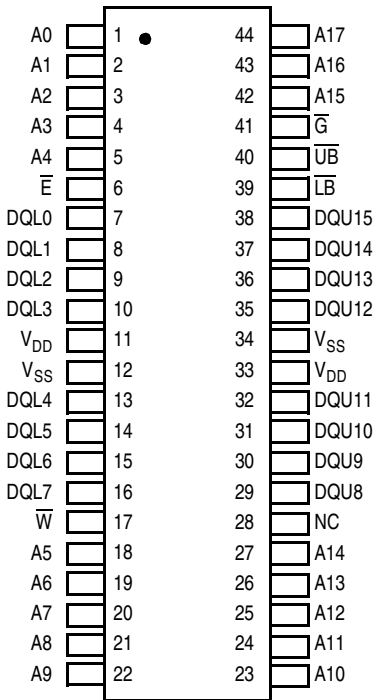


Table 1. Pin Functions

Signal Name	Function
A	Address input
\bar{E}	Chip enable
\bar{W}	Write enable
\bar{G}	Output enable
\bar{UB}	Upper byte select
\bar{LB}	Lower byte select
DQL	Data I/O, lower byte
DQU	Data I/O, upper byte
V_{DD}	Power supply
V_{SS}	Ground
NC	Do not connect this pin

Figure 2. MR2A16A in 44-Pin TSOP Type II Package

Timing Specifications

Read Mode

Table 9. Read Cycle Timing^{1, 2}

Parameter	Symbol	Min	Max	Unit
Read cycle time	t_{AVAV}	35	—	ns
Address access time	t_{AVQV}	—	35	ns
Enable access time ³	t_{ELQV}	—	35	ns
Output enable access time	t_{GLQV}	—	15	ns
Byte enable access time	t_{BLQV}	—	15	ns
Output hold from address change	t_{AXQX}	3	—	ns
Enable low to output active ^{4, 5}	t_{ELQX}	3	—	ns
Output enable low to output active ^{4, 5}	t_{GLQX}	0	—	ns
Byte enable low to output active ^{4, 5}	t_{BLQX}	0	—	ns
Enable high to output Hi-Z ^{4, 5}	t_{EHQZ}	0	15	ns
Output enable high to output Hi-Z ^{4, 5}	t_{GHQZ}	0	10	ns
Byte high to output Hi-Z ^{4, 5}	t_{BHQZ}	0	10	ns

NOTES:

- ¹ \bar{W} is high for read cycle.
- ² Due to product sensitivities to noise, power supplies must be properly grounded and decoupled, and bus contention conditions must be minimized or eliminated during read and write cycles.
- ³ Addresses valid before or at the same time \bar{E} goes low.
- ⁴ This parameter is sampled and not 100% tested.
- ⁵ Transition is measured ± 200 mV from steady-state voltage.

Write Mode

Table 10. Write Cycle Timing 1 (\overline{W} Controlled)^{1, 2, 3, 4, 5}

Parameter	Symbol	Min	Max	Unit
Write cycle time ⁶	t_{AVAV}	35	—	ns
Address set-up time	t_{AVWL}	0	—	ns
Address valid to end of write (\overline{G} high)	t_{AVWH}	18	—	ns
Address valid to end of write (\overline{G} low)	t_{AVWH}	20	—	ns
Write pulse width (\overline{G} high)	t_{WLWH} t_{WLEH}	15	—	ns
Write pulse width (\overline{G} low)	t_{WLWH} t_{WLEH}	15	—	ns
Data valid to end of write	t_{DVWH}	10	—	ns
Data hold time	t_{WHDX}	0	—	ns
Write low to data Hi-Z ^{7, 8, 9}	t_{WLQZ}	0	12	ns
Write high to output active ^{7, 8, 9}	t_{WHQX}	3	—	ns
Write recovery time	t_{WHAX}	12	—	ns

NOTES:

- ¹ A write occurs during the overlap of \overline{E} low and \overline{W} low.
- ² Due to product sensitivities to noise, power supplies must be properly grounded and decoupled and bus contention conditions must be minimized or eliminated during read and write cycles.
- ³ If \overline{G} goes low at the same time or after \overline{W} goes low, the output will remain in a high-impedance state.
- ⁴ After \overline{W} , \overline{E} , or $\overline{UB/LB}$ has been brought high, the signal must remain in steady-state high for a minimum of 2 ns.
- ⁵ The minimum time between \overline{E} being asserted low in one cycle to \overline{E} being asserted low in a subsequent cycle is the same as the minimum cycle time allowed for the device.
- ⁶ All write cycle timings are referenced from the last valid address to the first transition address.
- ⁷ This parameter is sampled and not 100% tested.
- ⁸ Transition is measured ± 200 mV from steady-state voltage.
- ⁹ At any given voltage or temperature, t_{WLQZ} max < t_{WHQX} min.

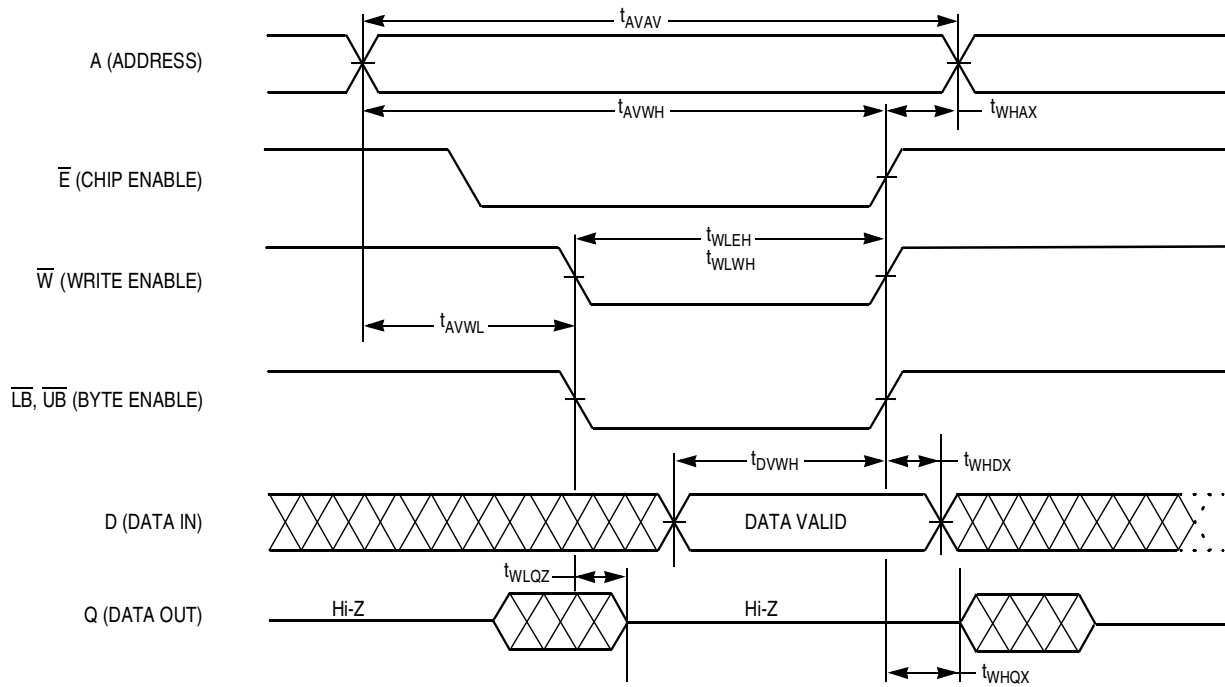


Figure 6. Write Cycle 1 (\bar{W} Controlled)

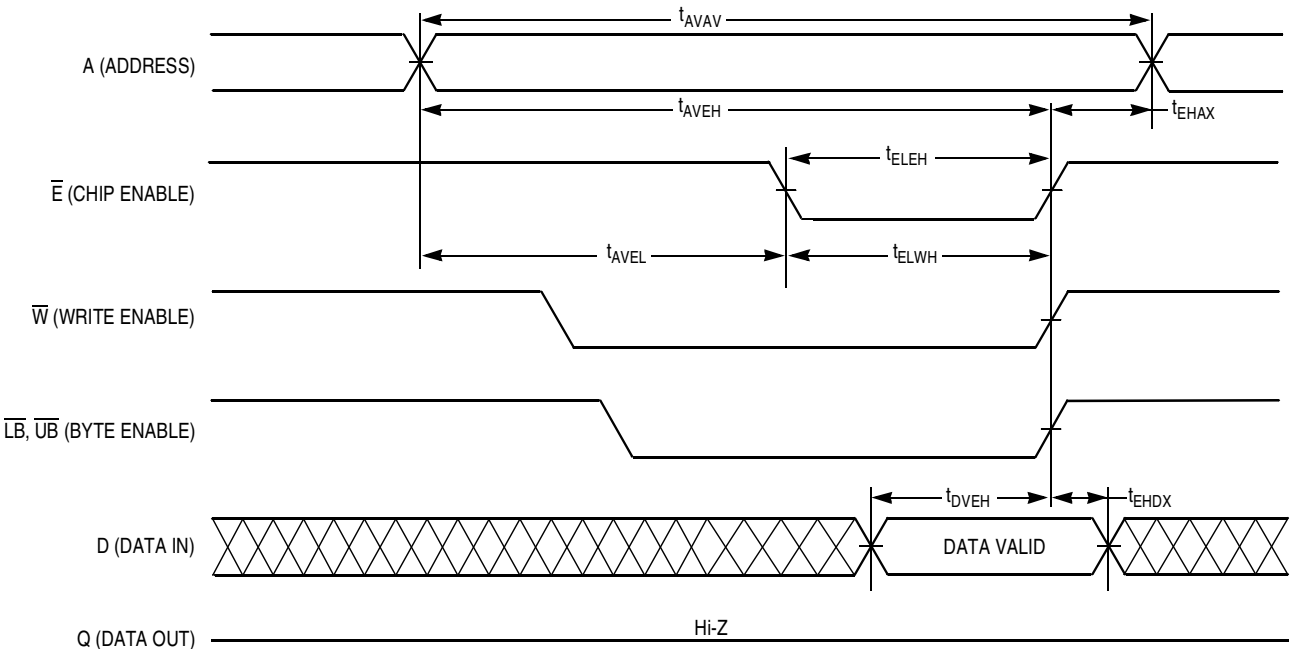


Figure 7. Write Cycle 2 (E-bar Controlled)

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Table 12. Write Cycle Timing 3 (LB/UB Controlled)^{1, 2, 3, 4, 5, 6}

Parameter	Symbol	Min	Max	Unit
Write cycle time ⁷	t_{AVAV}	35	—	ns
Address set-up time	t_{AVBL}	0	—	ns
Address valid to end of write (\bar{G} high)	t_{AVBH}	18	—	ns
Address valid to end of write (\bar{G} low)	t_{AVBH}	20	—	ns
Byte pulse width (\bar{G} high)	t_{BLEH} t_{BLWH}	15	—	ns
Byte pulse width (\bar{G} low)	t_{BLEH} t_{BLWH}	15	—	ns
Data valid to end of write	t_{DVBH}	10	—	ns
Data hold time	t_{BHDX}	0	—	ns
Write recovery time	t_{BHAX}	12	—	ns

NOTES:

- ¹ A write occurs during the overlap of \bar{E} low and \bar{W} low.
- ² Due to product sensitivities to noise, power supplies must be properly grounded and decoupled and bus contention conditions must be minimized or eliminated during read and write cycles.
- ³ If \bar{G} goes low at the same time or after \bar{W} goes low, the output will remain in a high-impedance state.
- ⁴ After \bar{W} , \bar{E} , or $\overline{UB/LB}$ has been brought high, the signal must remain in steady-state high for a minimum of 2 ns.
- ⁵ If both byte control signals are asserted, the two signals must have no more than 2 ns skew between them.
- ⁶ The minimum time between \bar{E} being asserted low in one cycle to \bar{E} being asserted low in a subsequent cycle is the same as the minimum cycle time allowed for the device.
- ⁷ All write cycle timings are referenced from the last valid address to the first transition address.

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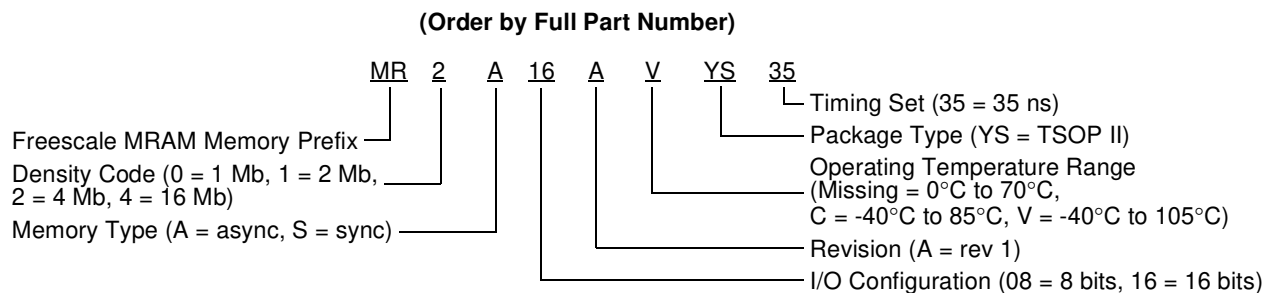
Ordering Information

This product is available in Commercial, Industrial, and Extended temperature versions.

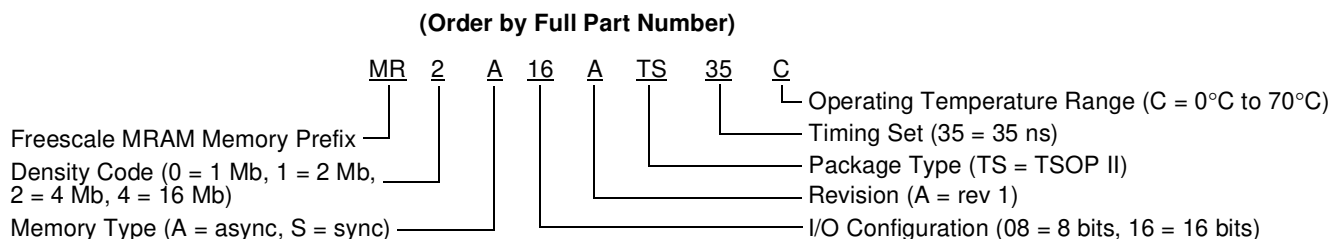
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- **Commercial** — Typically 5 year applications - personal computers, PDA's, portable telecom products, consumer electronics, etc.
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Current Part Numbering System (New Commercial, Industrial and Extended devices)



Legacy Part Numbering System (Legacy Commercial devices)



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Package Information

Table 13. Package Information

Device	Pin Count	Package Type	Designator	Case No.	Document No.	RoHS Compliant
MR2A16A	44	TSOP Type II	TS/YS ¹	924A-02	98ASS23673W	True

NOTES:

¹ TS and YS are both valid package codes for TSOP packages. The package is identical for both TS and YS codes.

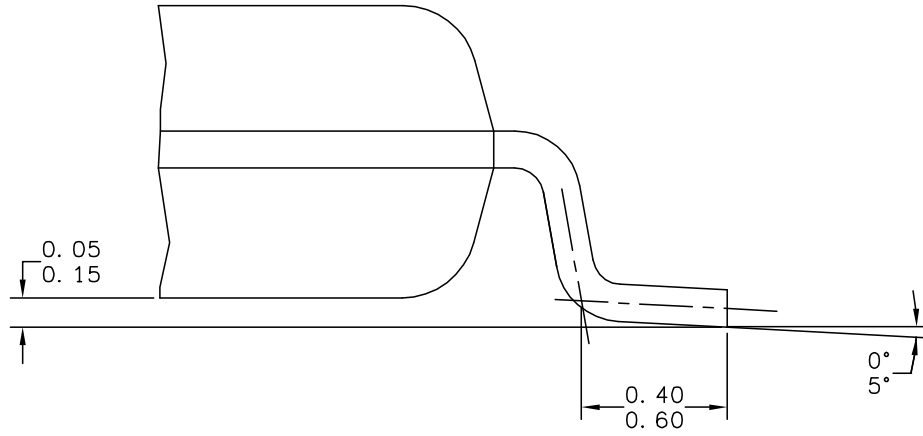
Revision History

Revision History

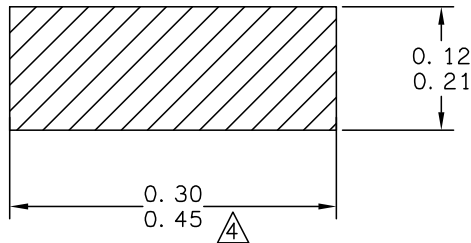
Revision	Date	Description of Change
4	18 Jun 2007	Added new Industrial and Extended temperature product information; updated part ordering information; changed to 2 ms delay after power up; power supply characteristics values updated to TBD for industrial and extended temperature devices.
5	21 Sep 2007	Changed MR2A16ATS35C product description to Legacy Commercial. Added the New Commercial temperature product (MR2A16AYS35) information. Table 3: MR2A16AYS35 H _{max_write} = 25 Oe. Table 4: MR2A16AYS35 has a 2 ms power up waiting period. Table 6: Applied values to TBD's in IDD specifications.
6	12 Nov 2007	Table 2: Changed IDDA to IDDR or IDDW. Table 13: Added note indicating that TS and YS are both valid package codes. Current Part Numbering System: Added commercial (missing letter) temperature range.

Mechanical Drawing

The following pages detail the package available to MR2A16A.



VIEW D
ROTATED 90° CW



SECTION E-E
40 PLACES

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TITLE: 44 LEAD TSOP, TYPE II, .400 WIDE	DOCUMENT NO: 98ASS23673W	REV: C	
	CASE NUMBER: 924A-02	17 MAY 2005	
	STANDARD: NON-JEDEC		

